## **AMENDMENTS TO THE CLAIMS:**

Please amend Claims 5-17, 20, 23-26 and 30 as follows, and cancel Claims 31-46 without prejudice and without disclaimer of subject matter. In accordance with the Revised Amendment Format, the status of all claims are presented below.

- 1. (Currently amended): A method of manufacturing an image displaying apparatus, comprising the steps of:
- a: disposing a substrate, on which an electrical conductor and a wiring connected to the conductor are formed, on a support; disposing a container on the substrate to cover covering—the conductor with a container except for a part of the wiring; setting the container into a desired atmosphere therein; and applying a voltage to the conductor through the part of wiring, whereby thereby forming an at least one electron-emitting device at a part of the conductor to thereby forming form an electron source substrate;

b: preparing a phosphor substrate on which <u>a</u> phosphor emitting light <u>responsive to an irradiation with an electron emitted from</u> by the electron-emitting device is arranged, and disposing the electron source substrate and the phosphor substrate within vacuum atmosphere;

c: carrying under a vacuum atmosphere one or both of the electron source substrate and the phosphor substrate into the vacuum atmosphere in a gettering process chamber, and subjecting to a gettering process only one substrate carried therein, or the one or both of the substrates carried therein; and

d: <u>after the gettering process</u>, carrying under the vacuum atmosphere the electron source substrate and the phosphor substrate in a seal-bonding process chamber, and subjecting to heat seal-bonding the substrates in an opposing state.

- 2. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said step of setting the container into a desired atmosphere therein comprises a step of exhausting the inside of the container.
- 3. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said step of setting the container into a desired atmosphere therein comprises a step of introducing a gas into the container.
- 4. (Original): A method of manufacturing an image displaying apparatus according to claim 1, further comprising a process of fixing, onto the support, the substrate used for the electron source substrate.
- 5. (Currently amended): A method of manufacturing an image displaying apparatus according to claim † 4, wherein the process of fixing, onto the support, the substrate used for the electron source substrate comprises a step of vacuum-adsorbing the substrate onto the support.

- 6. (Currently amended): A method of manufacturing an image displaying apparatus according to claim † 4, wherein the process of fixing, onto the support, the substrate used for the electron source substrate comprises a step of electrostatically-adsorbing the substrate onto the support.
- 7. (Currently amended): A method of manufacturing an image displaying apparatus according to claim † 4, wherein the said step of disposing, on the supporting member, the substrate used for the electron source substrate is performed while sandwiching a heat conductor between the substrate and the supporting member.
- 8. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said step of applying a voltage to the conductor comprises a step of adjusting the temperature of the substrate.
- 9. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said step of applying a voltage to the conductor comprises a step of heating the substrate used for the electron source substrate.
- 10. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the <u>said</u> step of applying a voltage to the conductor comprises a step of cooling the substrate used for the electron source substrate.

- 11. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said processes b, c, and d are processes set within an in-line.
- 12. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the <u>said</u> processes b, c, and d are processes set within an in-line, and a heat shielding material is disposed between the gettering process chamber and the seal-bonding process chamber.
- 13. (Currently amended): A method of manufacturing an image displaying apparatus according to claim ± 12, wherein the said heat shielding material is formed of a reflective metal.
- displaying apparatus according to claim 1, wherein the <u>said</u> processes b, c, and d are processes set within an in-line, and a gate valve is disposed between the gettering process chamber and the seal-bonding process chamber.
- 15. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the said processes b, c, and d are processes set on a star arrangement.

- displaying apparatus according to claim 1, wherein the <u>said</u> processes b, c, and d are processes set on a star arrangement, and the gettering process chamber and the seal-bonding process chamber are partitioned by an independent chamber.
- 17. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the phosphor exciting means comprises means for emitting electron beam.
- 18. (Original): A method of manufacturing an image displaying apparatus according to claim 1, wherein the electron source substrate comprises an outer frame fixedly disposed preliminary to its periphery.
- 19. (Original): A method of manufacturing an image displaying apparatus according to claim 1, wherein the electron source substrate comprises a spacer fixedly disposed preliminary to an inside thereof.
- 20. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the electron source substrate comprises the <u>an</u> outer frame fixedly disposed preliminary to its periphery, and the <u>a</u> spacer fixedly disposed preliminary to the <u>an</u> inside thereof.

- 21. (Original): A method of manufacturing an image displaying apparatus according to claim 1, wherein the phosphor substrate comprises an outer frame fixedly disposed preliminary to its periphery.
- 22. (Original): A method of manufacturing an image displaying apparatus according to claim 1, wherein the phosphor substrate comprises a spacer fixedly disposed preliminary to an inside thereof.
- 23. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the phosphor substrate comprises the an outer frame fixedly disposed preliminary to its periphery, and the a spacer fixedly disposed preliminary to the an inside thereof.
- 24. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the getter used in the above said process  $\underbrace{C}_{\underline{c}}$  is an evaporable getter such as a barium getter.
- 25. (Currently amended): A method of manufacturing an image displaying apparatus according to claim † 24, wherein the evaporable getter is a barium getter.

- 26. (Currently amended): A method of manufacturing an image displaying apparatus according to claim 1, wherein the <u>a</u> seal-bonding material used in the <u>above said</u> process d is a low melting point material.
- 27. (Original): A method of manufacturing an image displaying apparatus according to claim 26, wherein the low melting point material is a low melting point metal or an alloy thereof.
- 28. (Original): A method of manufacturing an image displaying apparatus according to claim 27, wherein the low melting point metal is indium or an alloy thereof.
- 29. (Original): A method of manufacturing an image displaying apparatus according to claim 26, wherein the low melting point material is frit glass.
- displaying apparatus according to claim 1, wherein the at least one electron-emitting device is plural electron-emitting devices, and further comprising a step of arranging the electron-emitting devices in a matrix, and forming wirings so as to connect in a matrix configuration the electron-emitting devices arranged in the matrix.

31-46. (Cancelled).